Tyrone Camarero Specifications



Camarero-SQI200A2R-224

Key Feature

Artificial Intelligence (AI), Business Intelligence, ERP, CRM, Scientific Virtualization, In-Memory Database, HCI, SAP HANA

- Quad Socket E (LGA-4677) 4th Generation Intel® Xeon® Scalable processors
- 64 DIMM Slots;
- Up to 16TB DDR5-4800MHz ECC RDIMM/RDIMM-3DS
- Optional PCle configurations up to 8 PCle slots with support for two double-width GPU/Accerlator cards
- Flexible networking options with 2 AIOM networking slot (OCP NIC 3.0 compatible)
- 24x 2.5" Hot-swap NVMe/SAS3/SATA3 Hybrid Drive bays (Default with 24 SAS3/-SATA3 drive bays);
- 2x internal M.2 NVMe/SATA;
- Optional RAID support via storage add-on card
- 6 heavy duty fans w/ optimal fan speed control
- 1600W Redundant Titanium Level power supplies





Processor/Cache

Processor Quad Socket E (LGA-4677) 4th Generation

Intel® Xeon® Scalable processors

System Memory

Memory Capacity

Memory Capacity: 64 DIMM slots, Up to 16TB: 64x 256 GB DRAM, Memory Type:

4800MHz ECC DDR5 RDIMM/RDIMM-3DS

Chipset

Chipset

Intel® C741

Expansion Slot

PCI-Express

3 PCIe 5.0 x8 FHFL slot(s), 1 PCIe 5.0 x16 FHFL slot(s), 2 PCIe 5.0 x16 FHHL slot(s), 1 PCIe 5.0 x16 AIOM slot(s), 1 PCIe 5.0 x8

AIOM slot(s)

Integrated Onboard:

LAN: 1 RJ45 Dedicated IPMI LAN port

Support for Intelligent Platform Management

IPMI: Interface v.2.0 IPMI 2.0 with virtual media

Interface v.2.0, IPMI 2.0 with virtual media over LAN and KVM-over-LAN support

Add-on Options

Raid Card

Optional

Optical Drive None

Drive bays

HDD Bays 24x 2.5" hot-swap NVMe/SAS3/SATA3

drive bays (24x 2.5" NVMe hybrid), 2 M.2 NVMe OR 2 M.2 SATA3

Power Supply

Power Supply 1600W Redundant Titanium Level

power supplies

Cooling System

Fans 6 Heavy duty counter-rotating 6cm

Fan(s)

Form Factor

Form Factor 2U Rackmount

Dimensions

Dimensions Height - 3.5" (87.9mm), Width-17.3"

(438.4mm), Depth-33.4" (849.3mm)

Email: Info@tyronesystems.com
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